

Electronic Patent Application Fee Transmittal

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|---|---|-----------------|---------------|-----------------------------|
| Application Number: | 10724515 | | | |
| Filing Date: | 26-Nov-2003 | | | |
| Title of Invention: | Method for electrochemically forming structures including non-parallel mating of contact masks and substrates | | | |
| First Named Inventor/Applicant Name: | Adam L. Cohen | | | |
| Filer: | Dennis R. Smalley | | | |
| Attorney Docket Number: | P-US024-A-MF | | | |
| Filed as Small Entity | | | | |
| Utility Filing Fees | | | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Miscellaneous-Filing: | | | | |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Post-Allowance-and-Post-Issuance: | | | | |
| Extension-of-Time: | | | | |
| Extension - 3 months with \$0 paid | 2253 | 1 | 510 | 510 |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-------------------|----------|----------|--------|----------------------|
| Miscellaneous: | | | | |
| Total in USD (\$) | | | | 510 |